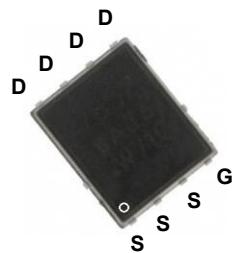
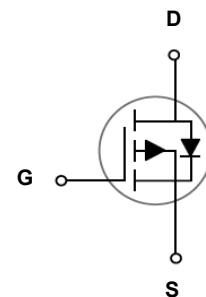


### Main Product Characteristics

$BV_{DSS}$	-40V
$R_{DS(ON)}$	15mΩ
$I_D$	-50A



PPAK5X6



Schematic Diagram

### Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



### Description

The GSFP0449 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

### Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	$V_{DS}$	-40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous ( $T_C=25^\circ\text{C}$ )	$I_D$	-50	A
Drain Current-Continuous ( $T_C=100^\circ\text{C}$ )		-32	
Drain Current-Pulsed <sup>1</sup>	$I_{DM}$	-200	A
Single Pulse Avalanche Energy <sup>2</sup>	$E_{AS}$	100	mJ
Single Pulse Avalanche Current <sup>2</sup>	$I_{AS}$	-45	A
Power Dissipation ( $T_C=25^\circ\text{C}$ )	$P_D$	82	W
Power Dissipation-Derate above 25°C		0.65	W/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.53	°C/W
Operating Junction Temperature Range	$T_J$	-55 To +150	°C
Storage Temperature Range	$T_{STG}$	-55 To +150	°C

### Electrical Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>On/Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$	-40	-	-	V
Drain-Source Leakage Current	$\text{I}_{\text{DS}(\text{S})}$	$\text{V}_{\text{DS}}=-40\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{T}_J=25^\circ\text{C}$	-	-	-1	$\mu\text{A}$
		$\text{V}_{\text{DS}}=-32\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{T}_J=125^\circ\text{C}$	-	-	-10	$\mu\text{A}$
Gate-Source Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm100$	nA
Static Drain-Source On-Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-15\text{A}$	-	12	15	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_D=-10\text{A}$	-	17	23	
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}, \text{I}_D=-250\mu\text{A}$	-1.2	-1.6	-2.5	V
Forward Transconductance	$\text{g}_{\text{fs}}$	$\text{V}_{\text{DS}}=-10\text{V}, \text{I}_D=3\text{A}$	-	11	-	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>3,4</sup>	$\text{Q}_g$	$\text{V}_{\text{DS}}=-20\text{V}, \text{I}_D=-25\text{A}, \text{V}_{\text{GS}}=-10\text{V}$	-	37	56	nC
Gate-Source Charge <sup>3,4</sup>	$\text{Q}_{\text{gs}}$		-	5	8	
Gate-Drain Charge <sup>3,4</sup>	$\text{Q}_{\text{gd}}$		-	8.5	13	
Turn-On Delay Time <sup>3,4</sup>	$\text{t}_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}}=-20\text{V}, \text{R}_G=6\Omega, \text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-25\text{A}$	-	9.6	15	nS
Rise Time <sup>3,4</sup>	$\text{t}_r$		-	28	42	
Turn-Off Delay Time <sup>3,4</sup>	$\text{t}_{\text{d}(\text{off})}$		-	45	68	
Fall Time <sup>3,4</sup>	$\text{t}_f$		-	11	17	
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=-20\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{F}=1\text{MHz}$	-	2070	3100	pF
Output Capacitance	$\text{C}_{\text{oss}}$		-	225	340	
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		-	170	255	
Gate Resistance	$\text{R}_g$	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=0\text{V}, \text{F}=1\text{MHz}$	-	6.8	-	$\Omega$
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	$\text{I}_s$	$\text{V}_G=\text{V}_D=0\text{V}, \text{Force Current}$	-	-	-50	A
Pulsed Source Current	$\text{I}_{\text{SM}}$		-	-	-100	A
Diode Forward Voltage	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=-1\text{A}, \text{T}_J=25^\circ\text{C}$	-	-	-1	V
Reverse Recovery Time <sup>3</sup>	$\text{t}_{\text{rr}}$	$\text{V}_R=-30\text{V}, \text{I}_s=-10\text{A}, \text{di/dt}=100\text{A}/\mu\text{s}, \text{T}_J=25^\circ\text{C}$	-	45	-	nS
Reverse Recovery Charge <sup>3</sup>	$\text{Q}_{\text{rr}}$		-	25	-	nC

Note:

- Repetitive rating: Pulsed width limited by maximum junction temperature.
- $\text{V}_{\text{DD}}=-25\text{V}, \text{V}_{\text{GS}}=-10\text{V}, \text{L}=0.1\text{mH}, \text{I}_{\text{AS}}=-45\text{A}, \text{R}_G=25\Omega$ , starting  $\text{T}_J=25^\circ\text{C}$ .
- Pulse test: pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
- Essentially independent of operating temperature.

## Typical Electrical and Thermal Characteristic Curves

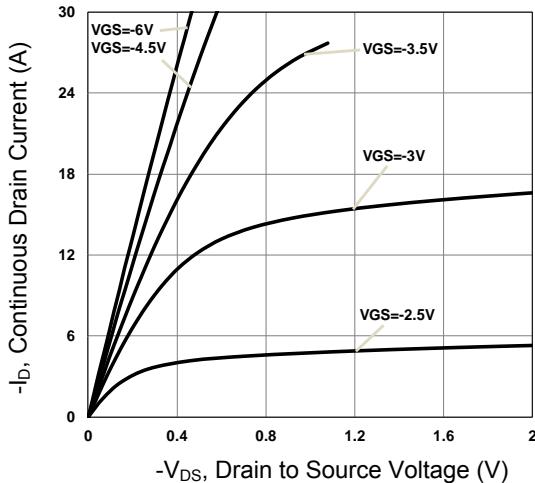


Figure 1. Typical Output Characteristics

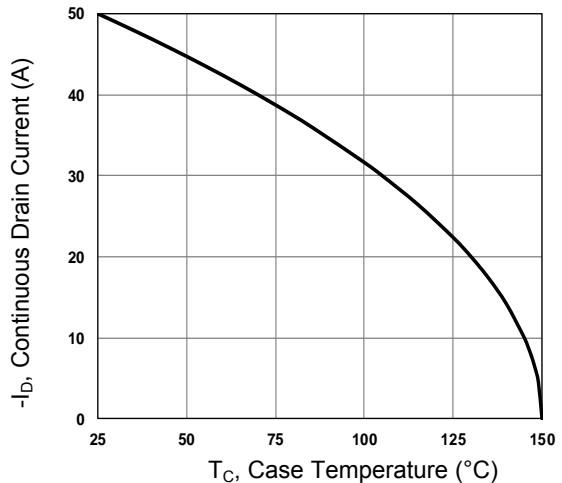


Figure 2. Continuous Drain Current vs.  $T_C$

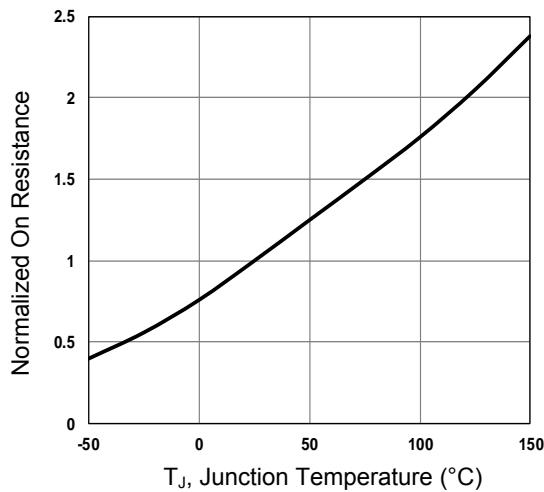


Figure 3. Normalized  $R_{DS(on)}$  vs.  $T_J$

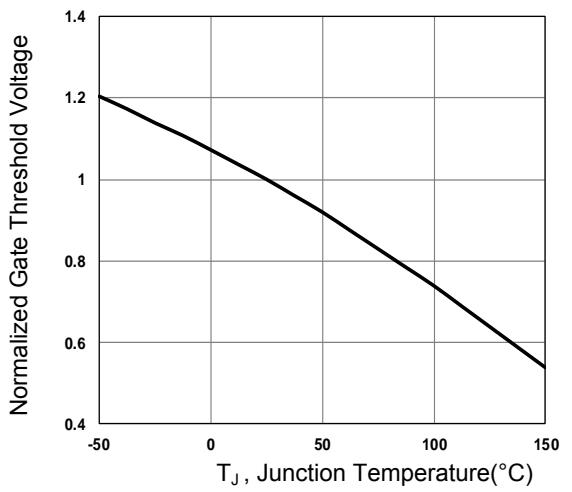


Figure 4. Normalized  $V_{th}$  vs.  $T_J$

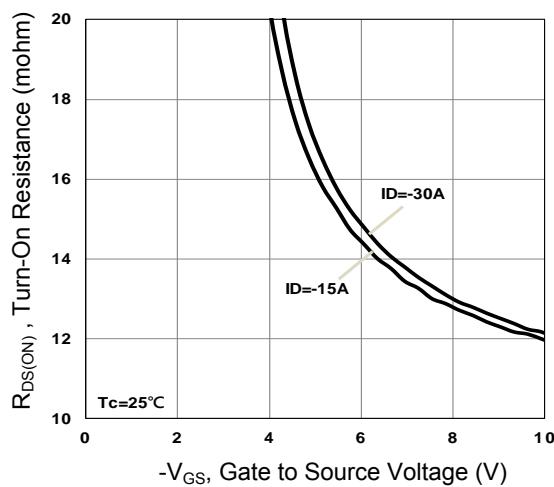


Figure 5. Turn-On Resistance vs.  $V_{GS}$

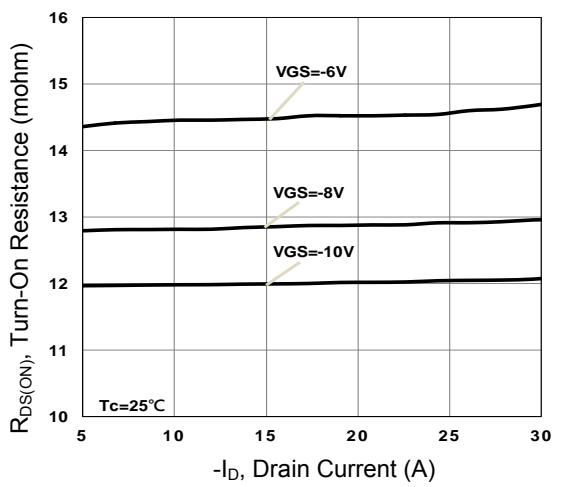


Figure 6. Turn-On Resistance vs.  $I_D$

## Typical Electrical and Thermal Characteristic Curves

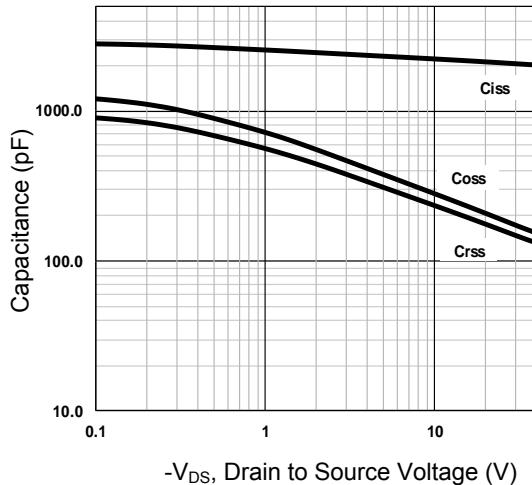


Figure 7. Capacitance Characteristics

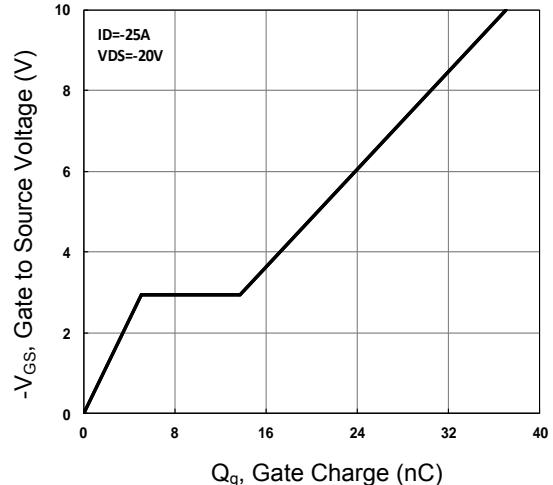


Figure 8. Gate Charge Characteristics

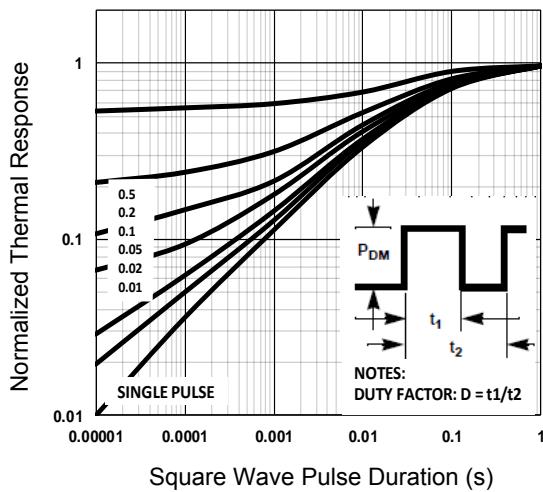


Figure 9. Normalized Transient Impedance

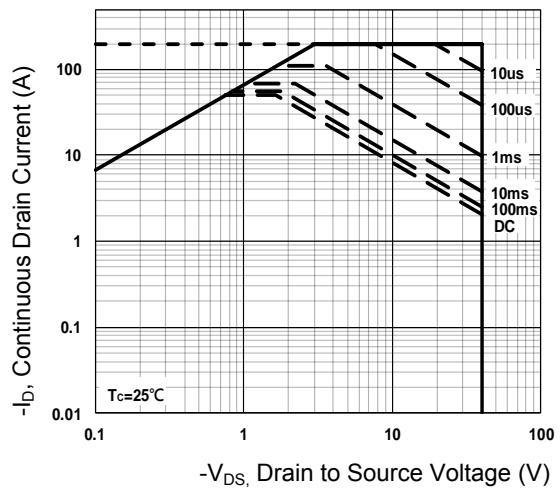


Figure 10. Maximum Safe Operation Area

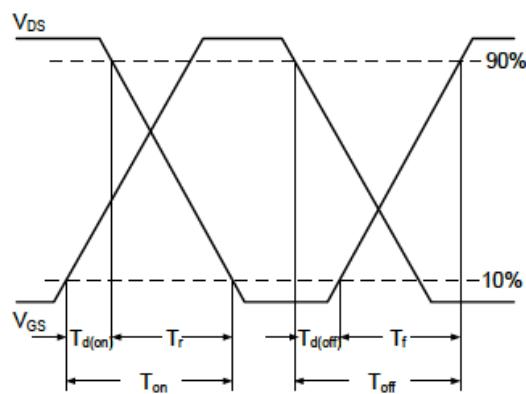


Figure 11. Switching Time Waveform

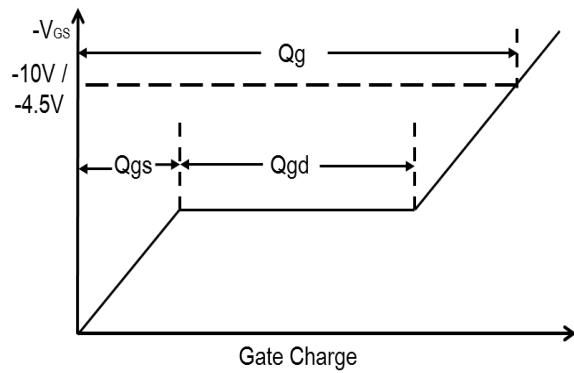
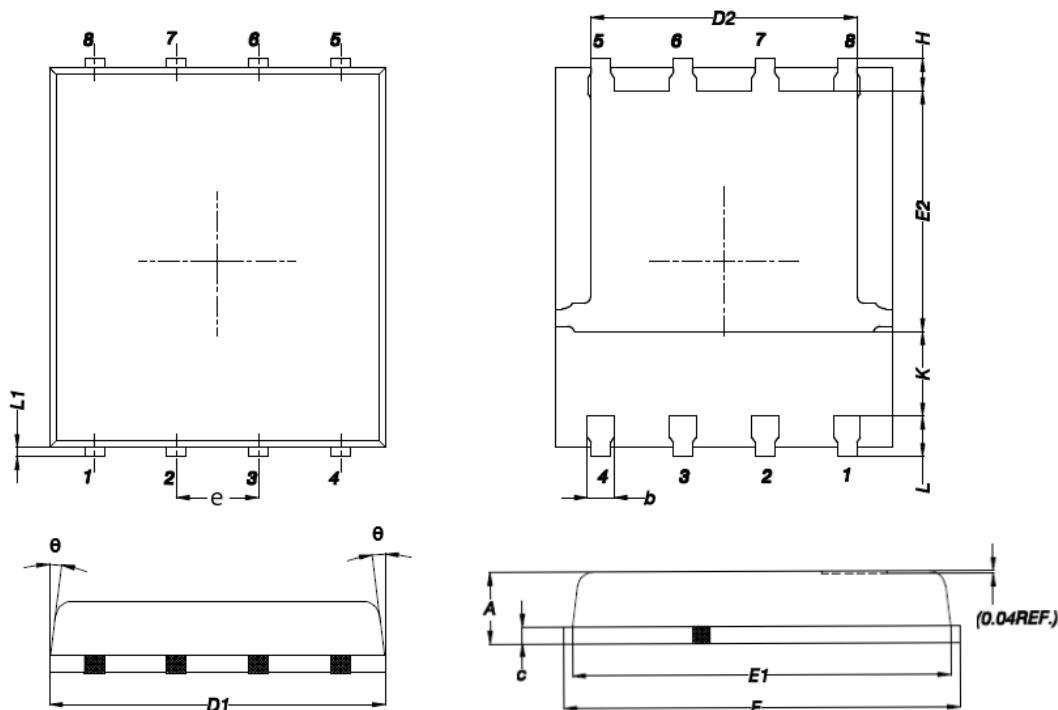


Figure 12. Gate Charge Waveform

### Package Outline Dimensions (PPAK5x6)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.200	0.850	0.047	0.031
b	0.510	0.300	0.020	0.012
C	0.300	0.200	0.012	0.008
D1	5.400	4.800	0.212	0.189
D2	4.310	3.610	0.170	0.142
E	6.300	5.850	0.248	0.230
E1	5.960	5.450	0.235	0.215
E2	3.920	3.300	0.154	0.130
e	1.27BSC		0.05BSC	
H	0.650	0.380	0.026	0.015
K	-	1.100	-	0.043
L	0.710	0.380	0.028	0.015
L1	0.250	0.050	0.009	0.002
θ	12°	0°	12°	0°